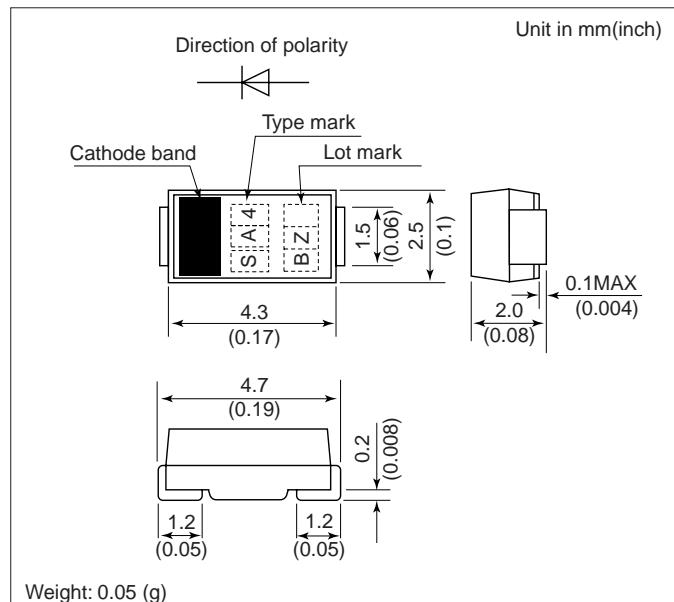


DSM1MA

FEATURES

- For general purpose
- High heat-resistant due to glass passivation.

OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS

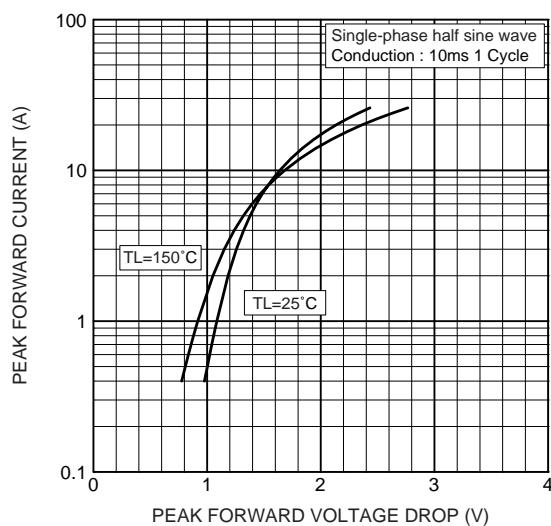
Items	Type	DSM1MA1	DSM1MA2	DSM1MA4
Repetitive Peak Reverse Voltage	V_{RRM}	V	100	200
Average Forward Current	$I_{F(AV)}$	A	1.0 (Single-phase half sine wave 180° conduction TL = 127°C)	
Surge(Non-Repetitive) Forward Current	I_{FSM}	A	25 (Without PIV, 10ms, conduction $T_j = 40^\circ\text{C}$ start)	
I^2t Limit Value	I^2t	A^2s	2.5 (Time = 2 ~ 10ms, I = RMS value)	
Operating Junction Temperature	T_j	$^\circ\text{C}$	-40 ~ +150	
Storage Temperature	T_{stg}	$^\circ\text{C}$	-40 ~ +150	

CHARACTERISTICS($T_L=25^\circ\text{C}$)

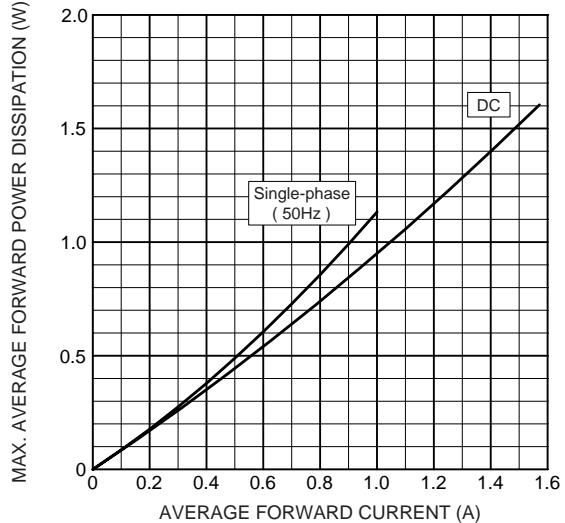
Items	Symbols	Units	Min.	Typ.	Max.	Test Conditions		
Peak Reverse Current	I_{RRM}	μA	—	—	20	DSM1MA1,2	Rated V_{RRM}	
					10			
Peak Forward Voltage	V_{FM}	V	—	—	1.1	$I_{FM}=1.0\text{Ap}$, Single-phase half sine wave 1 cycle		
Steady State Thermal Impedance	$R_{th(j-a)}$	$^\circ\text{C}/\text{W}$	—	—	120	On glass-epoxi substrate (□ 50mm Soldering land (□ 6mm)		
	$R_{th(j-l)}$				20			

DSM1MA

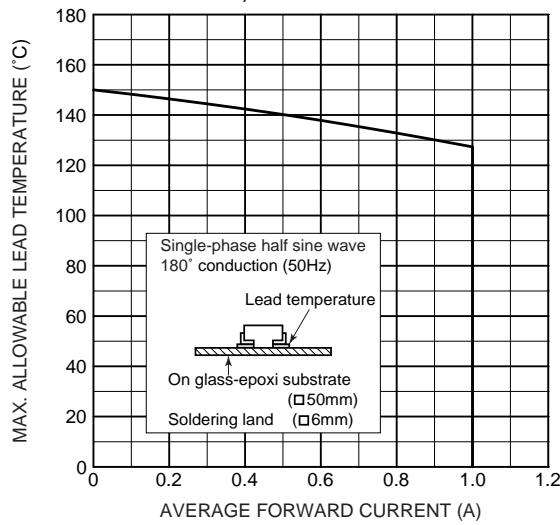
Forward characteristics



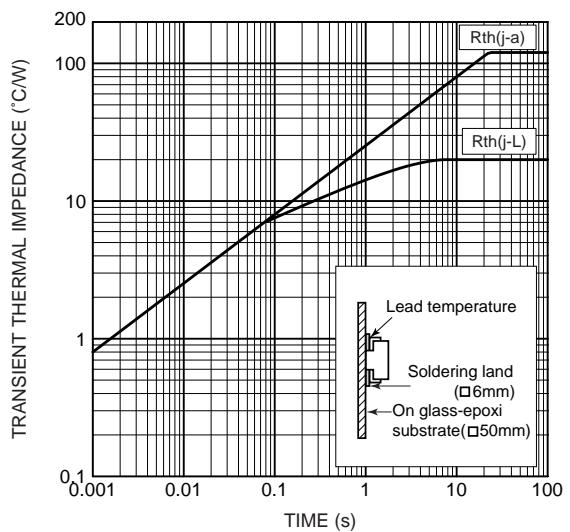
Max. average forward power dissipation (Resistive or inductive load)



Max. allowable lead temperature (Resistive or inductive load)



Transient thermal impedance



HITACHI POWER SEMICONDUCTORS

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